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#### Details

Product Status	Obsolete
Core Processor	HC08
Core Size	8-Bit
Speed	8MHz
Connectivity	SCI
Peripherals	LVD, POR, PWM
Number of I/O	16
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	A/D 7x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/nxp-semiconductors/mchc908mr8vfae">https://www.e-xfl.com/product-detail/nxp-semiconductors/mchc908mr8vfae</a>



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### 1.5.4 External Interrupt Pin ( $\overline{\text{IRQ}}$ )

$\overline{\text{IRQ}}$  is an asynchronous external interrupt pin. See **Section 16. External Interrupt (IRQ)**.

### 1.5.5 CGM Power Supply Pins ( $V_{\text{DDA}}$ and $V_{\text{SSA}}$ )

$V_{\text{DDA}}$  and  $V_{\text{SSA}}$  are the power supply pins for the analog portion of the clock generator module (CGM) and the analog-to-digital converter (ADC). Decoupling of these pins should be per the digital supply. See **Section 8. Clock Generator Module (CGM)** and **Section 18. Analog-to-Digital Converter (ADC)**.

### 1.5.6 ADC Reference Voltage Input Pin ( $V_{\text{REFH}}$ )

$V_{\text{REFH}}$  is the power supply input for setting the reference voltage. See **Section 18. Analog-to-Digital Converter (ADC)**.

### 1.5.7 External Filter Capacitor Pin (CGMXFC)

CGMXFC is an external filter capacitor connection for the CGM. See **Section 8. Clock Generator Module (CGM)**.

### 1.5.8 Port A Input/Output (I/O) Pins (PTA6/ATD6–PTA0/ATD0)

Port A is a 7-bit special function port, sharing all of its pins with the analog-to-digital converter (ADC). On the 32-pin QFP package, all seven bits (PTA6/ATD6–PTA0/ATD0) of the port are available. On the 28-pin package, four bits (PTA3/ATD3–PTA0/ATD0) are available.

PTA3–PTA0 have high current source and sink capability. See **Section 14. Input/Output (I/O) Ports**.

# Memory Map

Addr.	Register Name		Bit 7	6	5	4	3	2	1	Bit 0
\$FE0F	LVI Status and Control Register (LVISCR) See page <b>308</b> .	Read:	LVI-OUT	0	TRPS-EL	0	0	0	0	0
		Write:	R	R		R	R	R	R	R
		Reset:	0	0	0	0	0	0	0	0
\$FF7E	FLASH Block Protect Register (FLBPR) See page <b>63</b> .	Read:	BPR7	BPR6	BPR5	BPR4	BPR3	BPR2	BPR1	BPR0
		Write:								
		Reset:	Unaffected by reset							
\$FFFF	COP Control Register (COPCTL) See page <b>294</b> .	Read:	Low byte of reset vector							
		Write:	Clear COP counter							
		Reset:	Unaffected by reset							
U = Unaffected nate			R	= Reserved			<b>Bold</b>	= Buff- ered		= Unimplemented

Figure 2-2. Control, Status, and Data Registers (Sheet 10 of 10)



Configuration Register (CONFIG)

Table 6-2. Opcode Map

MSB LSB	Bit Manipulation		Branch	Read-Modify-Write						Control		Register/Memory							
	DIR	DIR	REL	DIR	INH	INH	IX1	SP1	IX	INH	INH	IMM	DIR	EXT	IX2	SP2	IX1	SP1	IX
	0	1	2	3	4	5	6	9E6	7	8	9	A	B	C	D	9ED	E	9EE	F
0	5 BRSET0 3 DIR	4 BSET0 2 DIR	3 BRA REL	4 NEG DIR	1 NEGA INH	1 NEGX INH	4 NEG IX1	5 NEG SP1	3 NEG IX	7 RTI INH	3 BGE REL	2 SUB IMM	3 SUB DIR	4 SUB EXT	4 SUB IX2	5 SUB SP2	3 SUB IX1	4 SUB SP1	2 SUB IX
1	5 BRCLR0 3 DIR	4 BCLR0 DIR	3 BRN REL	5 CBEQ DIR	4 CBEQA IMM	4 CBEQX IMM	5 CBEQ IX1+	6 CBEQ SP1	4 CBEQ IX+	4 RTS INH	3 BLT REL	2 CMP IMM	3 CMP DIR	4 CMP EXT	4 CMP IX2	5 CMP SP2	3 CMP IX1	4 CMP SP1	2 CMP IX
2	5 BRSET1 3 DIR	4 BSET1 DIR	3 BHI REL		5 MUL INH	7 DIV INH	3 NSA INH		2 DAA INH		3 BGT REL	2 SBC IMM	3 SBC DIR	4 SBC EXT	4 SBC IX2	5 SBC SP2	3 SBC IX1	4 SBC SP1	2 SBC IX
3	5 BRCLR1 3 DIR	4 BCLR1 DIR	3 BLS REL	4 COM DIR	1 COMA INH	1 COMX INH	4 COM IX1	5 COM SP1	3 COM IX	9 SWI INH	3 BLE REL	2 CPX IMM	3 CPX DIR	4 CPX EXT	4 CPX IX2	5 CPX SP2	3 CPX IX1	4 CPX SP1	2 CPX IX
4	5 BRSET2 3 DIR	4 BSET2 DIR	3 BCC REL	4 LSR DIR	1 LSRA INH	1 LSRX INH	4 LSR IX1	5 LSR SP1	3 LSR IX	1 TAP INH	2 TXS INH	2 AND IMM	3 AND DIR	4 AND EXT	4 AND IX2	5 AND SP2	3 AND IX1	4 AND SP1	2 AND IX
5	5 BRCLR2 3 DIR	4 BCLR2 DIR	3 BCS REL	4 STHX DIR	1 LDHX IMM	4 LDHX DIR	3 CPHX IMM		2 CPHX DIR	1 TPA INH	2 TSX INH	2 BIT IMM	3 BIT DIR	4 BIT EXT	4 BIT IX2	5 BIT SP2	3 BIT IX1	4 BIT SP1	2 BIT IX
6	5 BRSET3 3 DIR	4 BSET3 DIR	3 BNE REL	4 ROR DIR	1 RORA INH	1 RORX INH	4 ROR IX1	5 ROR SP1	3 ROR IX	2 PULA INH		2 LDA IMM	3 LDA DIR	4 LDA EXT	4 LDA IX2	5 LDA SP2	3 LDA IX1	4 LDA SP1	2 LDA IX
7	5 BRCLR3 3 DIR	4 BCLR3 DIR	3 BEQ REL	4 ASR DIR	1 ASRA INH	1 ASRX INH	4 ASR IX1	5 ASR SP1	3 ASR IX	2 PSHA INH	1 TAX INH	2 AIS IMM	3 STA DIR	4 STA EXT	4 STA IX2	5 STA SP2	3 STA IX1	4 STA SP1	2 STA IX
8	5 BRSET4 3 DIR	4 BSET4 DIR	3 BHCC REL	4 LSL DIR	1 LSLA INH	1 LSLX INH	4 LSL IX1	5 LSL SP1	3 LSL IX	2 PULX INH	1 CLC INH	2 EOR IMM	3 EOR DIR	4 EOR EXT	4 EOR IX2	5 EOR SP2	3 EOR IX1	4 EOR SP1	2 EOR IX
9	5 BRCLR4 3 DIR	4 BCLR4 DIR	3 BHCS REL	4 ROL DIR	1 ROLA INH	1 ROLX INH	4 ROL IX1	5 ROL SP1	3 ROL IX	2 PSHX INH	1 SEC INH	2 ADC IMM	3 ADC DIR	4 ADC EXT	4 ADC IX2	5 ADC SP2	3 ADC IX1	4 ADC SP1	2 ADC IX
A	5 BRSET5 3 DIR	4 BSET5 DIR	3 BPL REL	4 DEC DIR	1 DECA INH	1 DECX INH	4 DEC IX1	5 DEC SP1	3 DEC IX	2 PULH INH	2 CLI INH	2 ORA IMM	3 ORA DIR	4 ORA EXT	4 ORA IX2	5 ORA SP2	3 ORA IX1	4 ORA SP1	2 ORA IX
B	5 BRCLR5 3 DIR	4 BCLR5 DIR	3 BMI REL	5 DBNZ DIR	3 DBNZA INH	3 DBNZX INH	5 DBNZ IX1	6 DBNZ SP1	4 DBNZ IX	2 PSHH INH	2 SEI INH	2 ADD IMM	3 ADD DIR	4 ADD EXT	4 ADD IX2	5 ADD SP2	3 ADD IX1	4 ADD SP1	2 ADD IX
C	5 BRSET6 3 DIR	4 BSET6 DIR	3 BMC REL	4 INC DIR	1 INCA INH	1 INCX INH	4 INC IX1	5 INC SP1	3 INC IX	1 CLRH INH	1 RSP INH		2 JMP DIR	3 JMP EXT	4 JMP IX2		3 JMP IX1		2 JMP IX
D	5 BRCLR6 3 DIR	4 BCLR6 DIR	3 BMS REL	3 TST DIR	1 TSTA INH	1 TSTX INH	3 TST IX1	4 TST SP1	2 TST IX		1 NOP INH	2 BSR REL	3 JSR DIR	4 JSR EXT	6 JSR IX2		5 JSR IX1		4 JSR IX
E	5 BRSET7 3 DIR	4 BSET7 DIR	3 BIL REL		5 MOV DD	4 MOV DIX+	3 MOV IMD		4 MOV IX+D	1 STOP INH	*	2 LDX IMM	3 LDX DIR	4 LDX EXT	4 LDX IX2	5 LDX SP2	3 LDX IX1	4 LDX SP1	2 LDX IX
F	5 BRCLR7 3 DIR	4 BCLR7 DIR	3 BIH REL	3 CLR DIR	1 CLRA INH	1 CLR X INH	3 CLR IX1	4 CLR SP1	2 CLR IX	1 WAIT INH	1 TXA INH	2 AIX IMM	3 STX DIR	4 STX EXT	4 STX IX2	5 STX SP2	3 STX IX1	4 STX SP1	2 STX IX

INH Inherent  
IMM Immediate  
DIR Direct  
EXT Extended  
DD Direct-Direct  
IX+D Indexed-Direct

REL Relative  
IX Indexed, No Offset  
IX1 Indexed, 8-Bit Offset  
IX2 Indexed, 16-Bit Offset  
IMD Immediate-Direct  
DIX+ Direct-Indexed

SP1 Stack Pointer, 8-Bit Offset  
SP2 Stack Pointer, 16-Bit Offset  
IX+ Indexed, No Offset with Post Increment  
IX1+ Indexed, 1-Byte Offset with Post Increment

\*Pre-byte for stack pointer indexed instructions

Low Byte of Opcode in Hexadecimal

MSB LSB	0	High Byte of Opcode in Hexadecimal
0	5 BRSET0 3 DIR	Cycles Opcode Mnemonic Number of Bytes / Addressing Mode



## 7.4.2.3 Illegal Opcode Reset

The SIM decodes signals from the CPU to detect illegal instructions. An illegal instruction sets the ILOP bit in the SIM reset status register (SRSR) and causes a reset.

Because the MC68HC08MR8 has stop mode disabled by bit 1 in the CONFIG register, execution of the STOP instruction will cause an illegal opcode reset if stop mode has not been enabled by setting CONFIG register bit 1.

## 7.4.2.4 Illegal Address Reset

An opcode fetch from addresses other than FLASH, I/O, or RAM addresses generates an illegal address reset (unimplemented locations within memory map). The SIM verifies that the CPU is fetching an opcode prior to asserting the ILAD bit in the SIM reset status register (SRSR) and resetting the MCU. A data fetch from an unmapped address does not generate a reset.

## 7.4.2.5 Low-Voltage Inhibit (LVI) Reset

The low-voltage inhibit module (LVI) asserts its output to the SIM when the  $V_{DD}$  voltage falls to the  $LVI_{LVRX}$  voltage and remains at or below that level for at least nine consecutive CPU cycles. The LVI bit in the SIM reset status register (SRSR) is set, and the external reset pin ( $\overline{RST}$ ) is held low while the SIM counter counts out 4096 CGMXCLK cycles. Sixty-four CGMXCLK cycles later, the CPU is released from reset to allow the reset vector sequence to occur. The SIM actively pulls down the  $\overline{RST}$  pin for all internal reset sources.

The operating range of the VCO is programmable for a wide range of frequencies and for maximum immunity to external noise, including supply and CGMXFC noise. The VCO frequency is bound to a range from roughly one-half to twice the center-of-range frequency,  $f_{VRS}$ . Modulating the voltage on the CGMXFC pin changes the frequency within this range. By design,  $f_{VRS}$  is equal to the nominal center-of-range frequency,  $f_{NOM}$ , (4.9152 MHz) times a linear factor L, or  $(L) f_{NOM}$ .

CGMRCLK is the PLL reference clock, a buffered version of CGMXCLK. CGMRCLK runs at a frequency,  $f_{RCLK}$ , and is fed to the PLL through a buffer. The buffer output is the final reference clock, CGMRDV, running at a frequency,  $f_{RDV} = f_{RCLK}$ .

The VCO's output clock, CGMVCLK, running at a frequency  $f_{VCLK}$ , is fed back through a programmable modulo divider. The modulo divider reduces the VCO clock by a factor, N. The divider's output is the VCO feedback clock, CGMVDV, running at a frequency,  $f_{VDV} = f_{VCLK}/N$ . See **8.4.2.4 Programming the PLL** for more information.

The phase detector then compares the VCO feedback clock, CGMVDV, with the final reference clock, CGMRDV. A correction pulse is generated based on the phase difference between the two signals. The loop filter then slightly alters the dc voltage on the external capacitor connected to CGMXFC based on the width and direction of the correction pulse. The filter can make fast or slow corrections depending on its mode, described in **8.4.2.2 Acquisition and Tracking Modes**. The value of the external capacitor and the reference frequency determines the speed of the corrections and the stability of the PLL.

The lock detector compares the frequencies of the VCO feedback clock, CGMVDV, and the final reference clock, CGMRDV. Therefore, the speed of the lock detector is directly proportional to the final reference frequency,  $f_{RDV}$ . The circuit determines the mode of the PLL and the lock condition based on this comparison.

## Clock Generator Module (CGM)

### 8.5.4 PLL Analog Power Pin ( $V_{DDA}$ )

$V_{DDA}$  is a power pin used by the analog portions of the PLL. Connect the  $V_{DDA}$  pin to the same voltage potential as the  $V_{DD}$  pin.

**NOTE:** Route  $V_{DDA}$  carefully for maximum noise immunity and place bypass capacitors as close as possible to the package.

### 8.5.5 Oscillator Enable Signal (SIMOSCEN)

The SIMOSCEN signal comes from the system integration module (SIM) and enables the oscillator and PLL.

### 8.5.6 Crystal Output Frequency Signal (CGMXCLK)

CGMXCLK is the crystal oscillator output signal. It runs at the full speed of the crystal ( $f_{XCLK}$ ) and comes directly from the crystal oscillator circuit. **Figure 8-3** shows only the logical relation of CGMXCLK to OSC1 and OSC2 and may not represent the actual circuitry. The duty cycle of CGMXCLK is unknown and may depend on the crystal and other external factors. Also, the frequency and amplitude of CGMXCLK can be unstable at startup.

### 8.5.7 CGM Base Clock Output (CGMOUT)

CGMOUT is the clock output of the CGM. This signal goes to the SIM, which generates the MCU clocks. CGMOUT is a 50 percent duty cycle clock running at twice the bus frequency. CGMOUT is software programmable to be either the oscillator output, CGMXCLK, divided by two or the VCO clock, CGMVCLK, divided by two.

### 8.5.8 CGM CPU Interrupt (CGMINT)

CGMINT is the interrupt signal generated by the PLL lock detector.

Upon power-on reset, if the received bytes of the security code do not match the data at locations \$FFF6–\$FFFD, the host fails to satisfy the security feature. The MCU remains in monitor mode, but reading a ROM location returns an invalid value and trying to execute code from ROM causes an illegal address reset. After receiving the eight security bytes from the host, the MCU transmits a break character, signifying that it is ready to receive a command.

**NOTE:** *The MCU does not transmit a break character until after the host sends the eight security bytes.*

To determine whether the security code entered is correct, check to see if bit 6 of RAM address \$60 is set. If it is, then the correct security code has been entered and ROM can be accessed.

If the security sequence fails, the device can be reset (via power-pin reset only) and brought up in monitor mode to attempt another entry.

After failing the security sequence, the FLASH memory can also be bulk erased by executing an erase routine that was downloaded into internal RAM. The bulk erase operation clears the security code locations so that all eight security bytes become \$FF.

counter reaches the value in the registers of an output compare channel, the TIMA can set, clear, or toggle the channel pin. Output compares can generate TIMA CPU interrupt requests.

## 11.4.3.1 Unbuffered Output Compare

Any output compare channel can generate unbuffered output compare pulses as described in **11.4.3 Output Compare**. The pulses are unbuffered because changing the output compare value requires writing the new value over the old value currently in the TIMA channel registers.

An unsynchronized write to the TIMA channel registers to change an output compare value could cause incorrect operation for up to two counter overflow periods. For example, writing a new value before the counter reaches the old value but after the counter reaches the new value prevents any compare during that counter overflow period. Also, using a TIMA overflow interrupt routine to write a new, smaller output compare value may cause the compare to be missed. The TIMA may pass the new value before it is written.

Use these methods to synchronize unbuffered changes in the output compare value on channel x:

- When changing to a smaller value, enable channel x output compare interrupts and write the new value in the output compare interrupt routine. The output compare interrupt occurs at the end of the current output compare pulse. The interrupt routine has until the end of the counter overflow period to write the new value.
- When changing to a larger output compare value, enable TIMA overflow interrupts and write the new value in the TIMA overflow interrupt routine. The TIMA overflow interrupt occurs at the end of the current counter overflow period. Writing a larger value in an output compare interrupt routine (at the end of the current pulse) could cause two output compares to occur in the same counter overflow period.

## 11.4.3.2 Buffered Output Compare

Channels 0 and 1 can be linked to form a buffered output compare channel whose output appears on the PTB3/TCH0A pin. The TIMA channel registers of the linked pair alternately control the output.

## 12.4.3 Output Compare

With the output compare function, the TIMB can generate a periodic pulse with a programmable polarity, duration, and frequency. When the counter reaches the value in the registers of an output compare channel, the TIMB can set, clear, or toggle the channel pin. Output compares can generate TIMB CPU interrupt requests.

### 12.4.3.1 Unbuffered Output Compare

Any output compare channel can generate unbuffered output compare pulses as described in **12.4.3 Output Compare**. The pulses are unbuffered because changing the output compare value requires writing the new value over the old value currently in the TIMB channel registers.

An unsynchronized write to the TIMB channel registers to change an output compare value could cause incorrect operation for up to two counter overflow periods. For example, writing a new value before the counter reaches the old value but after the counter reaches the new value prevents any compare during that counter overflow period. Also, using a TIMB overflow interrupt routine to write a new, smaller output compare value may cause the compare to be missed. The TIMB may pass the new value before it is written.

Use these methods to synchronize unbuffered changes in the output compare value on channel x:

- When changing to a smaller value, enable channel x output compare interrupts and write the new value in the output compare interrupt routine. The output compare interrupt occurs at the end of the current output compare pulse. The interrupt routine has until the end of the counter overflow period to write the new value.
- When changing to a larger output compare value, enable TIMB overflow interrupts and write the new value in the TIMB overflow interrupt routine. The TIMB overflow interrupt occurs at the end of the current counter overflow period. Writing a larger value in an output compare interrupt routine (at the end of the current pulse) could cause two output compares to occur in the same counter overflow period.

## Timer Interface B (TIMB)

In input capture mode ( $MSxB-MSxA = 0:0$ ), reading the high byte of the TIMB channel x registers (TBCHxH) inhibits input captures until the low byte (TBCHxL) is read.

In output compare mode ( $MSxB-MSxA \neq 0:0$ ), writing to the high byte of the TIMB channel x registers (TBCHxH) inhibits output compares until the low byte (TBCHxL) is written.

Register Name and Address: TBCH0H — \$0057

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
Write:								
Reset:	Indeterminate after reset							

Register Name and Address: TBCH0L — \$0058

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Write:								
Reset:	Indeterminate after reset							

Register Name and Address: TBCH1H — \$005A

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
Write:								
Reset:	Indeterminate after reset							

Register Name and Address: TBCH1L — \$005B

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Write:								
Reset:	Indeterminate after reset							

**Figure 12-9. TIMB Channel Registers (TBCH0H/L–TBCH1H/L)**

- Interrupt-driven operation with eight interrupt flags:
  - Transmitter empty
  - Transmission complete
  - Receiver full
  - Idle receiver input
  - Receiver overrun
  - Noise error
  - Framing error
  - Parity error
- Receiver framing error detection
- Hardware parity checking
- 1/16 bit-time noise detection

## 13.4 Functional Description

The SCI allows full-duplex, asynchronous, NRZ serial communication among the MCU and remote devices, including other MCUs. The transmitter and receiver of the SCI operate independently, although they use the same baud rate generator. During normal operation, the CPU monitors the status of the SCI, writes the data to be transmitted, and processes received data.

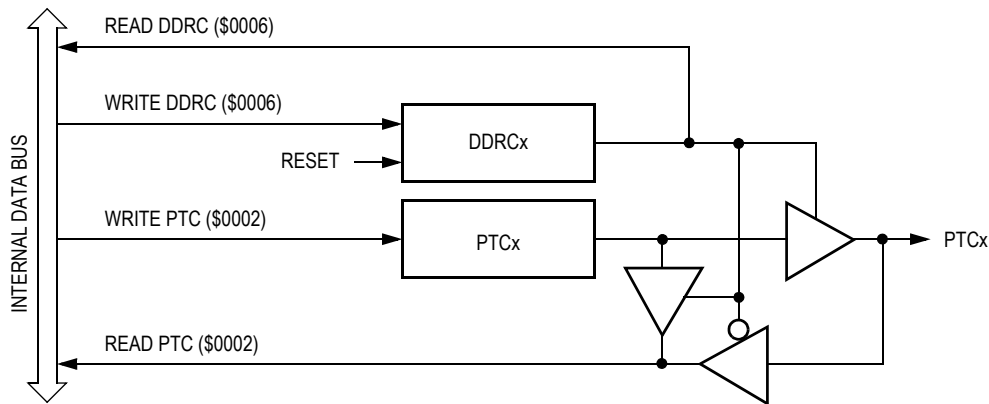
**Figure 13-1** shows the structure of the SCI module. **Figure 13-2** provides a summary of the input/output (I/O) registers.



# Serial Communications Interface (SCI)

**Table 13-7. SCI Baud Rate Selection Examples**

SCP1:SCP0	Prescaler Divisor (PD)	SCR2:SCR1: SCR0	Baud Rate Divisor (BD)	Baud Rate (f <sub>OP</sub> = 7.3728 MHz)	Baud Rate (f <sub>OP</sub> = 8.00 MHz)
00	1	000	1	115,200.00	125,000.00
00	1	001	2	57,600.00	62,500.00
00	1	010	4	28,800.00	31,250.00
00	1	011	8	14,400.00	15,625.00
00	1	100	16	7200.00	7812.50
00	1	101	32	3600.00	3906.25
00	1	110	64	1800.00	1953.13
00	1	111	128	900.00	976.56
01	3	000	1	38,400.00	41,666.67
01	3	001	2	19,200.00	20,833.33
01	3	010	4	9600.00	10,416.67
01	3	011	8	4800.00	5208.33
01	3	100	16	2400.00	2604.17
01	3	101	32	1200.00	1302.08
01	3	110	64	600.00	651.04
01	3	111	128	300.00	325.52
10	4	000	1	28,800.00	31,250.00
10	4	001	2	14,400.00	15,625.50
10	4	010	4	7200.00	7812.50
10	4	011	8	3600.00	3906.25
10	4	100	16	1800.00	1953.13
10	4	101	32	900.00	976.56
10	4	110	64	450.00	488.28
10	4	111	128	225.00	244.14
11	13	000	1	8861.54	9615.38
11	13	001	2	4430.77	4807.69
11	13	010	4	2215.38	2403.85
11	13	011	8	1107.69	1201.92
11	13	100	16	553.85	600.96
11	13	101	32	276.92	300.48
11	13	110	64	138.46	150.24
11	13	111	128	69.23	75.12



**Figure 14-10. Port C I/O Circuit**

When bit DDRCx is a logic 1, reading address \$0002 reads the PTCx data latch. When bit DDRCx is a logic 0, reading address \$0002 reads the voltage level on the pin. The data latch can always be written, regardless of the state of its data direction bit. **Table 14-3** summarizes the operation of the port C pins.

**Table 14-3. Port C Pin Functions**

DDRC Bit	PTC Bit	I/O Pin Mode	Accesses to DDRC	Accesses to PTC	
			Read/Write	Read	Write
0	X <sup>(1)</sup>	Input, Hi-Z <sup>(2)</sup>	DDRC[1:0]	Pin	PTC[1:0] <sup>(3)</sup>
1	X	Output	DDRC[1:0]	PTC[1:0]	PTC[1:0]

1. X = don't care
2. Hi-Z = high impedance on PTC0 and a pull-down  $R_{PD}$  on PTC1
3. Writing affects data register, but does not affect input.

## Section 16. External Interrupt (IRQ)

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### 16.2 Introduction

This section describes the external interrupt module, which supports external interrupt functions.

### 16.3 Features

Features of the IRQ module include:

- A dedicated external interrupt pin,  $\overline{\text{IRQ}}$
- Hysteresis buffers



## Revision History

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### Introduction

This section contains the revision history for the MC68HC908MR8  
advance information data book.

### Changes from Rev 3.0 published in April 2002 to Rev 4.0 published in July 2002

Section	Page (in Rev 0.4)	Description of change
Electrical Specifications	343	V <sub>OL</sub> max updated for I <sub>Load</sub> = 15 mA Stop I <sub>DD</sub> limits updated for different temperature specs

**variable** — A value that changes during the course of program execution.

**VCO** — See voltage-controlled oscillator.

**vector** — A memory location that contains the address of the beginning of a subroutine written to service an interrupt or reset.

**voltage-controlled oscillator (VCO)** — A circuit that produces an oscillating output signal of a frequency that is controlled by a dc voltage applied to a control input.

**waveform** — A graphical representation in which the amplitude of a wave is plotted against time.

**wired-OR** — Connection of circuit outputs so that if any output is high, the connection point is high.

**word** — A set of two bytes (16 bits).

**write** — The transfer of a byte of data from the CPU to a memory location.

**X** — The lower byte of the index register (H:X) in the CPU08.

**Z** — The zero bit in the condition code register of the CPU08. The CPU08 sets the zero bit when an arithmetic operation, logical operation, or data manipulation produces a result of \$00.